## **DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD FOR FORMING MULTILAYER CIRCUIT STRUCTURE AND SUBSTRATE HAVING MULTILAYER CIRCUIT STRUCTURE

the specification	on of which is attached hereto un	less the following is ch	ecked		
	nas United States Applica umber <u>PCT/JP03/04114</u> and wa			as PCT International	
	hat I have reviewed and understa ended by any amendment referr		above-identified specification,	including the	
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pa	tentability as defined in Title 3	37, Code of Federal	
for patent or in	foreign priority benefits under T ventor's certificate listed below ificate having a filing date before	and have also identified	l below any foreign application	eign application(s) n for patent or	
(List prior foreign				Priority Claimed	
(List prior foreign applications. See note A)	2002-142564	Japan	17/May/2002	☑ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
		(0)		☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
	(Number)	(Country)		☐ Yes ☐ No	
(See note B)	(Number) See attached list for additional	(Country) prior foreign applicatio	(Day/Month/Year Filed)		
insofar as the s in the manner   information wh	the benefit under Title 35, Unite ubject matter of each of the clair provided by the first paragraph of the ich is material to patentability arecame available between the fili	ed States Code, § 120 ons of this application is of Title 35, United States defined in Title 37, Co	of any United States application in the prior United States application of the prior United Code, § 112, I acknowledge ode of Federal Regulations.	ted States application e the duty to disclose	
(List prior U.S. Applications)			State	Status	
	(Application Serial No.)	(Filing Date)	Patented Pend	ing  Abandoned	
	(Application Serial No.)	(Filing Date)	_ Patented Pend	ing  Abandoned	
	(Application Serial No.)	(Filing Date)	_ Patented Pend	ing 🗌 Abandoned	
	(Application Serial No.)	(Filing Date)	_ Patented  Pend	ing  Abandoned	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

## Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

ee note C	Full name of sole or i	irst inventor (given name, family name)	Yasuhiro WAKIZAKA Date //// / / / / / / / / / / / / / / / /
700	Inventor's signature Residence	Jasuhiro Wakizaka	- Oii Timber / Cop
		Tokyo JAPAN	_ · JAIAN
	Post Office Address	c/o ZEON Corporation, 6-1, Marune	ouchi 2-chome, Chiyoda-ku, Tokyo
		100-8323 Japan	
0 (	<b>(1)</b>		
<i>ユ</i> ~		nventor (given name, family name)	Akihiko FURUYA
O ·	Inventor's signature	Akihiko Furuya	Date 29 /0ctober /200 x
	Residence	Tokyo JAPAN	Citizenship JAPAN TOX
	Post Office Address	c/o TOPPAN PRINTING Co.,Ltd.,	<u> </u>
		1-5-1, Taito, Taito-ku, Tokyo 110-85	560 Japan
71	(7)		
3 t		ventor (given name, family name)	Keiichirou YASUDA
	Inventor's signature	Keiichiran Yanda	Date 3/ Movember /2004
	Residence	Kumamoto JAPAN	Citizenship JAPAN
	Post Office Address	c/o OGATA Industrial Co.,Ltd.,	
		2-9-9, Kamikumamoto, Kumamoto-s	hi, Kumamoto 860-0079 Japan
1/10	d)		
40	Full name of fourth in	nventor (given name, family name)	Tomovuki BABA
ι	Inventor's signature	Jomoyuki Baba	Date 3/november 12004
	Residence	Kumamoto JAPAN	Citizenship JAPAN
	Post Office Address	c/o Kumabou Metal Kabushikigaish	a,
		4-15, Nagaminenishi 1-chome, Kuma	amoto-shi, Kumamoto 862-0937 Japan
	Full name of figh inv	entor (given name, family name)	
	Inventor's signature	chtor (given hame, family hame)	Date
	Residence		Citizenship
	Post Office Address		
	Full many of single in-		
	Inventor's signature	ventor (given name, family name)	Date
	Residence		Citizenship
	Post Office Address		